

## PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT3361585

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MING-HSIEN CHOU	05/10/2015
DING-YUAN CHEN	05/10/2015
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14717196
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<b>NAME OF SUBMITTER:</b>	PETER DETORRE
<b>SIGNATURE:</b>	/Peter Detorre/
<b>DATE SIGNED:</b>	05/20/2015
This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 2</b>	
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**ASSIGNMENT AND DECLARATION  
FOR UTILITY OR DESIGN PATENT  
APPLICATION**

Attorney Docket  
Number

First Named  
Inventor

CHOU, MING-HSIEN

**COMPACT OPTICAL AND LASER SYSTEMS, AND ULTRAFAST LASER  
UTILIZING THE SAME**

*(Title of the invention)*

As a below named inventor, I hereby declare that:

This assignment and declaration is directed to:

☒ The attached application

**OR**

☐ United States Application Number or PCT International application number \_\_\_\_\_  
filed on \_\_\_\_\_ (MM/DD/YYYY)

The above-identified application was made or authorized to be made by me.

I believe I am the original or an original joint inventor of the claimed invention in the application.

I hereby acknowledge that any wilful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

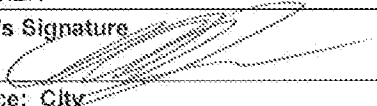
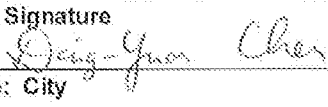
As a below named inventor, I hereby sell, assign and transfer unto to HC PHOTONICS CORP., a corporation of Taiwan, herein referred to as "Assignee", whose mailing address is F4, No.2, Technology Rd. V, Hsinchu Science Park, Hsinchu 300, Taiwan, the full and exclusive right to the said invention in the United States and the entire right, title and interest in and to any and all Patents which may be granted therefor in the United States, I hereby authorize and request the Commissioner of Patents and Trademarks to issue said United States Patent, the entire right, title, and interest in and to the same, for the Assignee's sole use and benefit; and for the use and benefit of the Assignee's legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

(Page 1 of 2)

TP130733-US

**PATENT**  
**REEL: 035679 FRAME: 0203**

**ASSIGNMENT AND DECLARATION — Utility or Design Patent  
Application**

<b>LEGAL NAME OF SOLE OR FIRST INVENTOR:</b>			
Given Name (first and middle [if any]) MING-HSIEN		Family Name or Surname CHOU	
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Inventor's Signature		Date (Optional)	
Residence: City	State	Country	
Mailing Address			
City	State	Zip	Country
<input type="checkbox"/> Additional inventors are being named on the ___ supplemental sheet(s) attached hereto.			

[Page 2 of 2]

TP130733-US